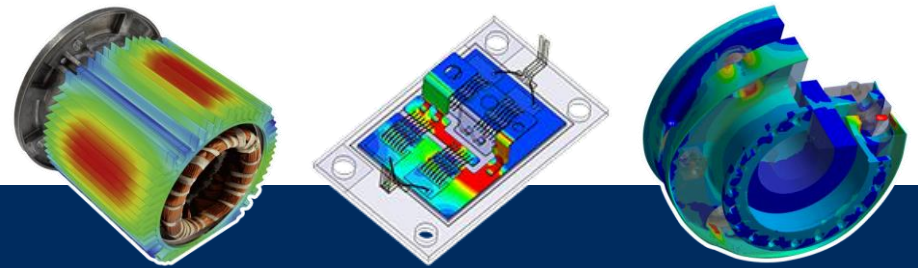


Simulation is more than Software<sup>®</sup>



## Simulationsgestützte Entwicklung Leistungselektronischer Schaltungslayouts

Auswirkungen parasitärer RLC auf das Schaltverhalten verstehen und optimieren

# Power Electronics as Enabler for an Energy Efficient World

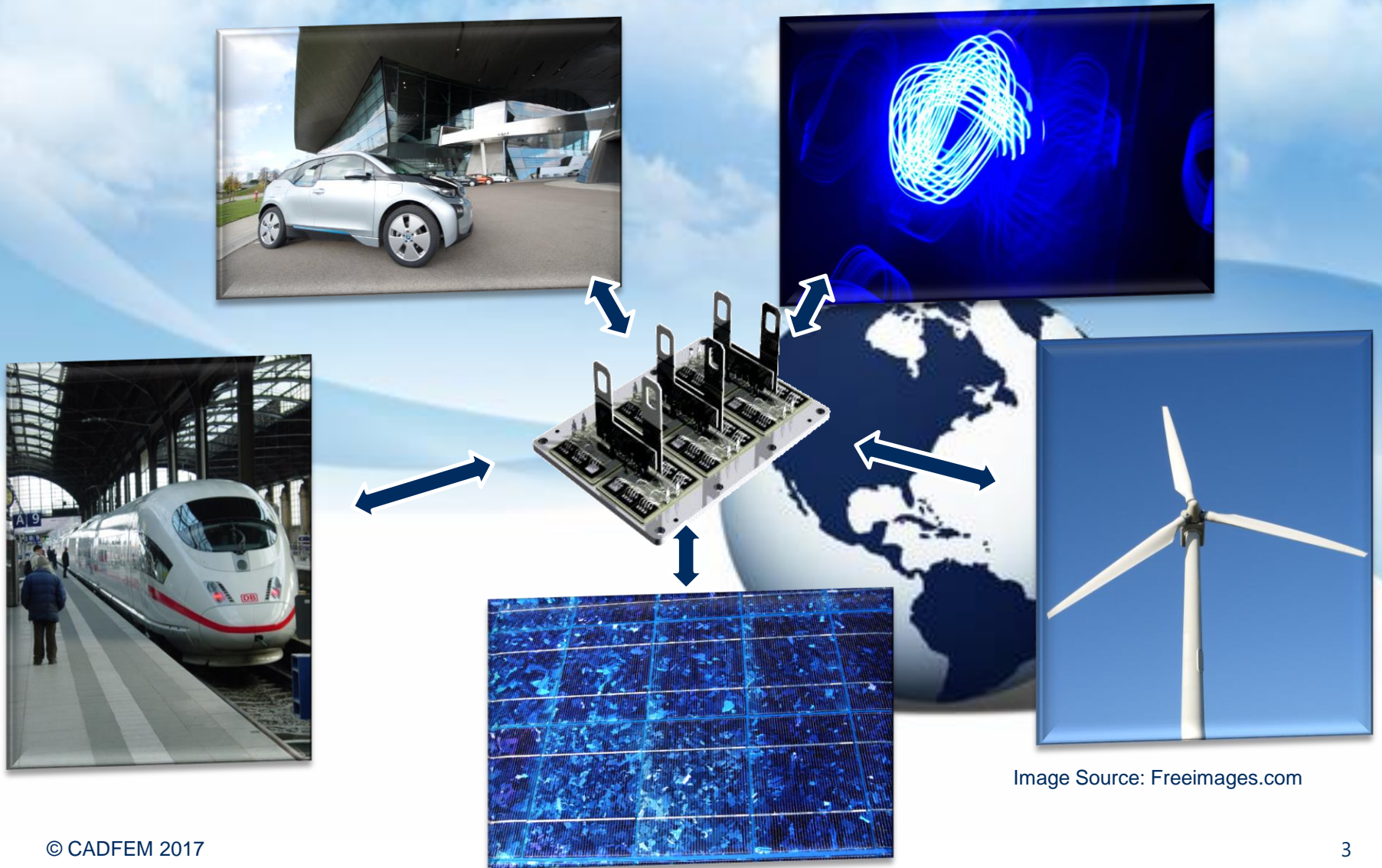
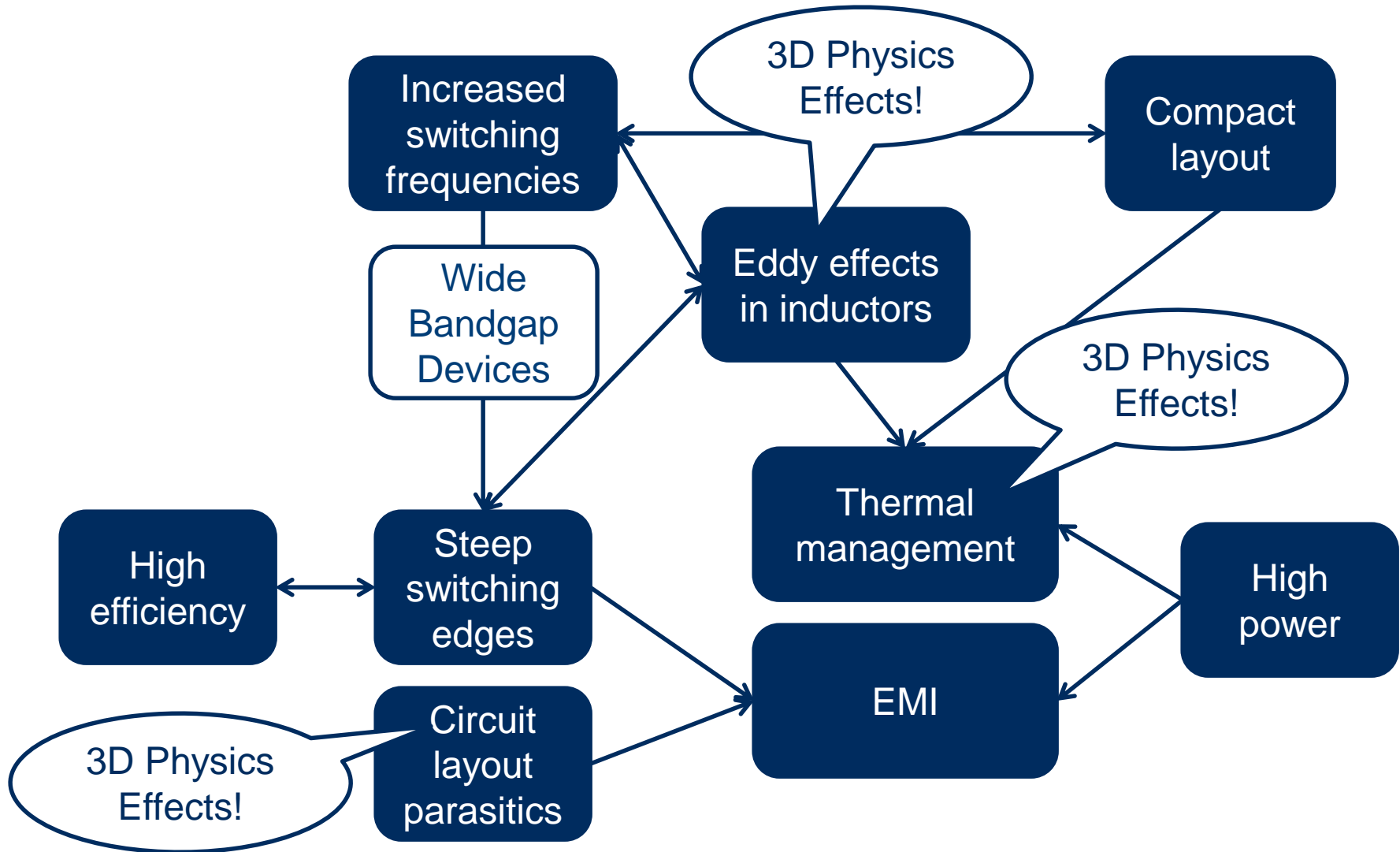


Image Source: Freeimages.com

# New Challenges in Hardware Development for Power Electronics



## Hardware Development for Power Electronics

- Typical applications:
  - Inverters
  - DC-DC
  - Inductors, chokes, transformers
- Typical questions:
  - Designed inductances and coupling factors
  - Efficiency
  - Parasitic inductances of connection to bus capacitors or parallel IGBTs
  - Switching behavior and EMI
  - Current load capacity
  - Thermal management

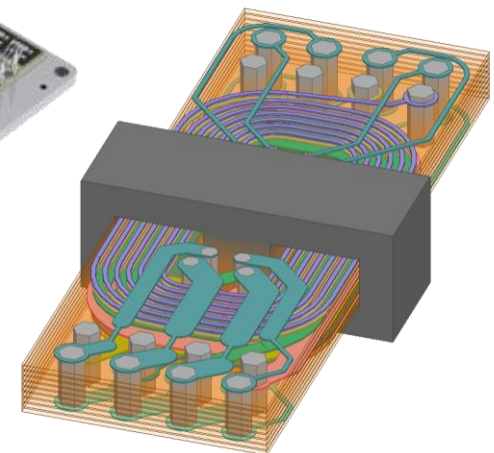
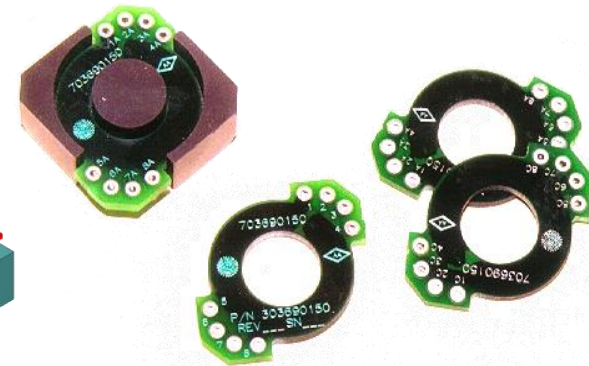
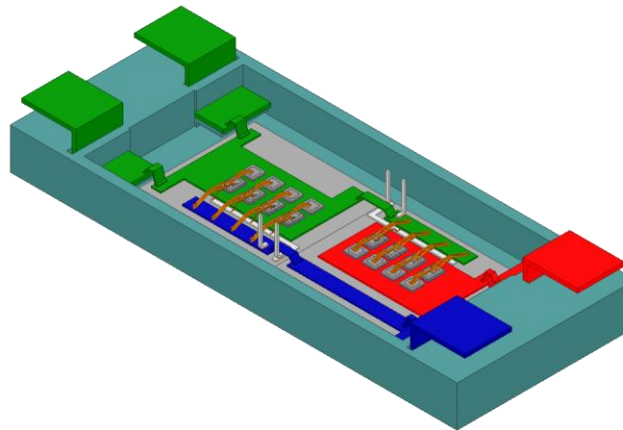
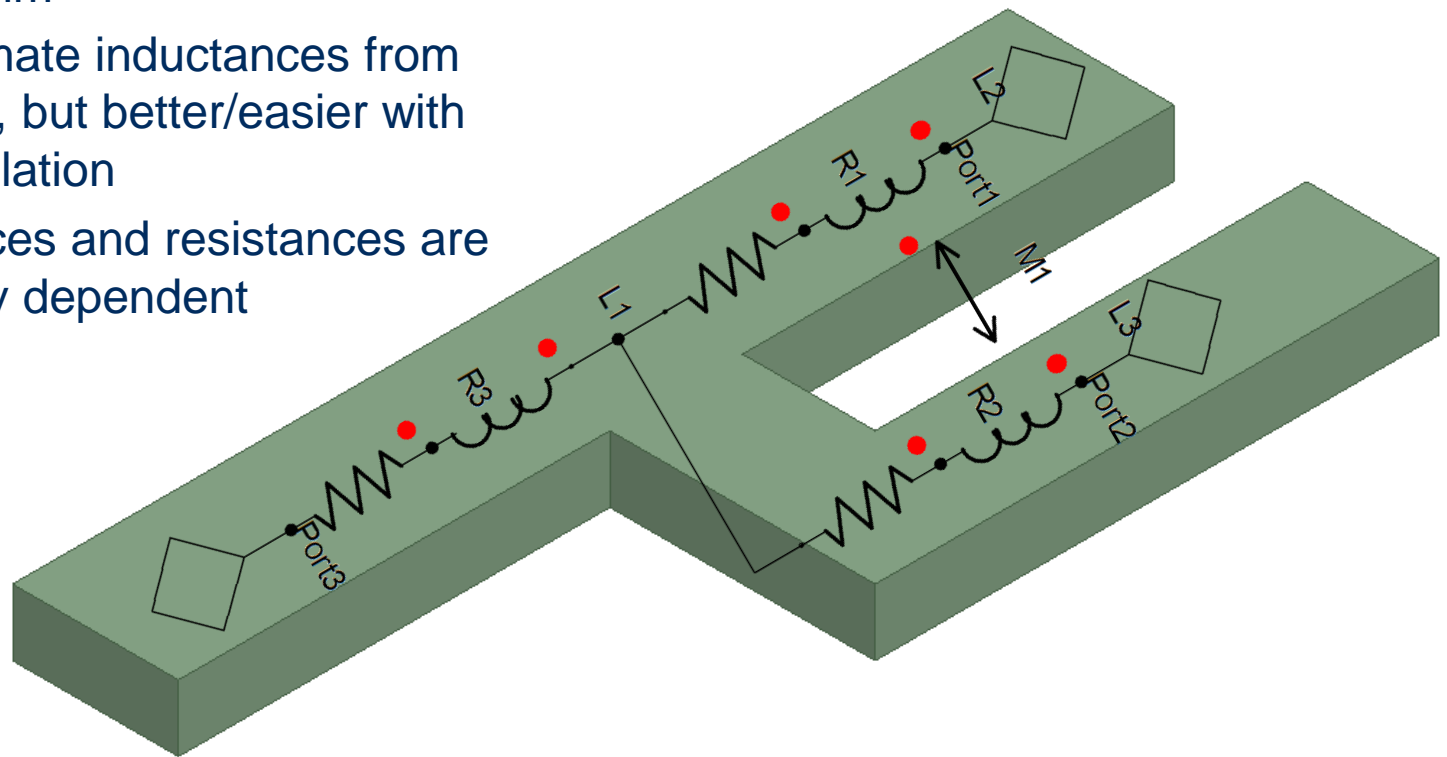


Image source: ANSYS, CADFEM

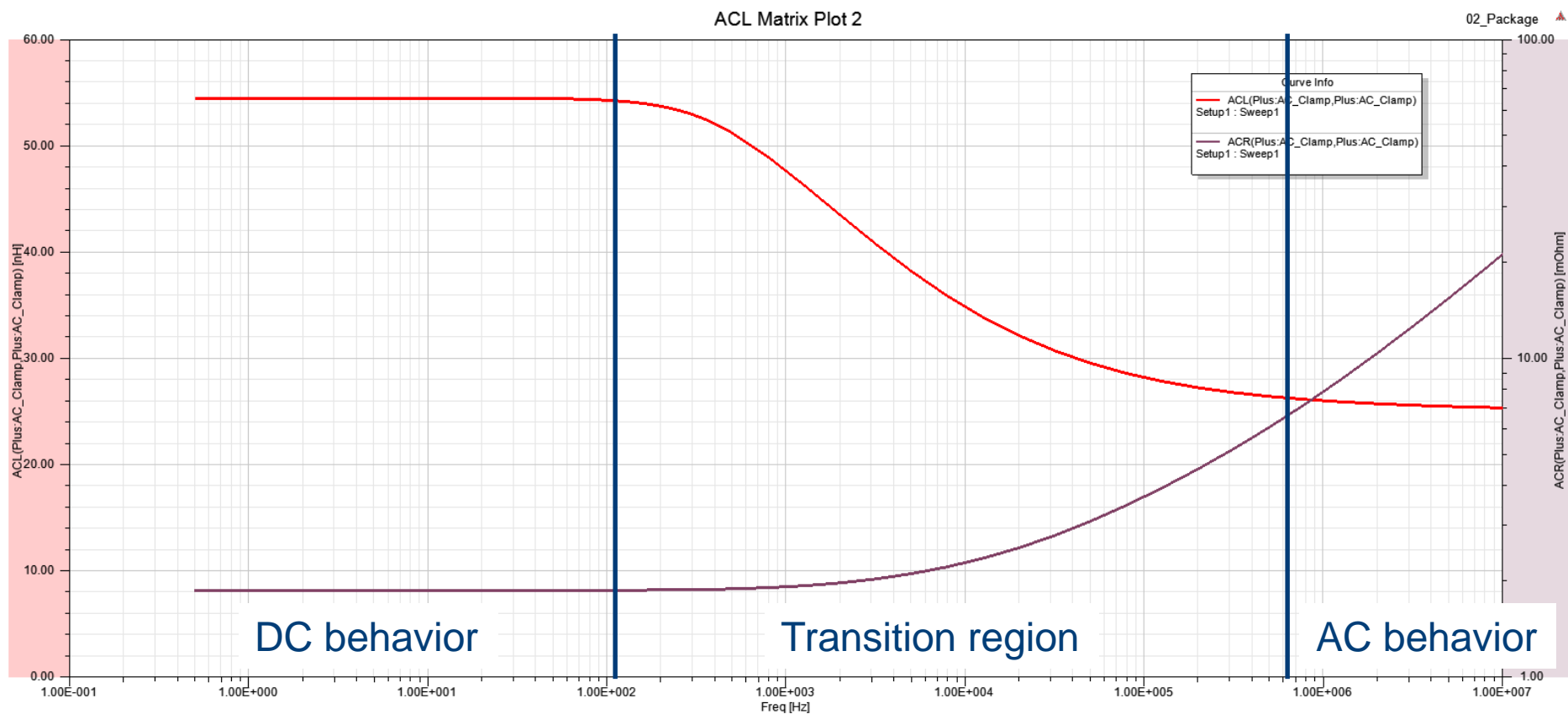
# Layout Parasitics

- Dimensional analysis:
  - $\mu_0 = 1 \text{ nH/mm}$
  - Can estimate inductances from geometry, but better/easier with field simulation
  - Inductances and resistances are frequency dependent



# Frequency Dependant Effects

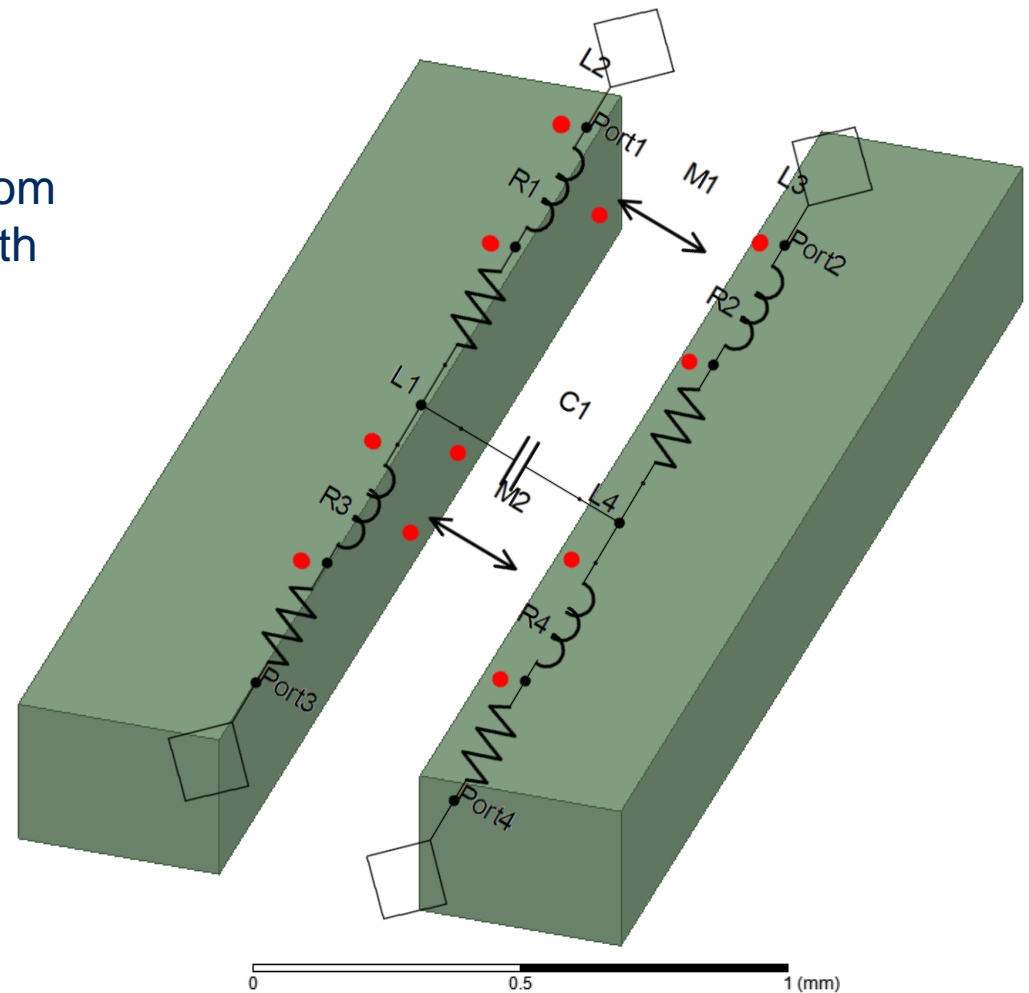
- Skin effect
- Proximity Effect





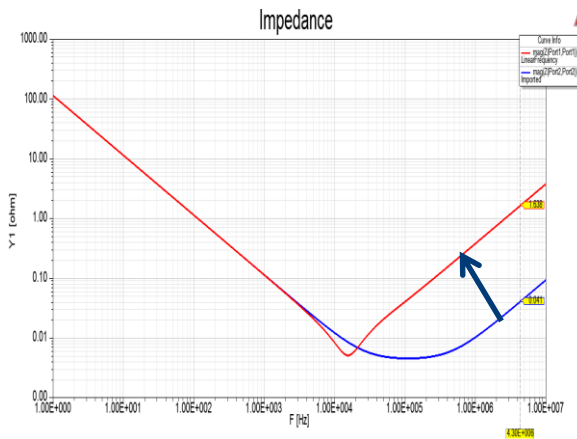
# Layout Parasitics

- Dimensional analysis:
  - $\epsilon_0 = 9\text{pF/m}$
  - Can estimate capacitances from geometry, but better/easier with field simulation

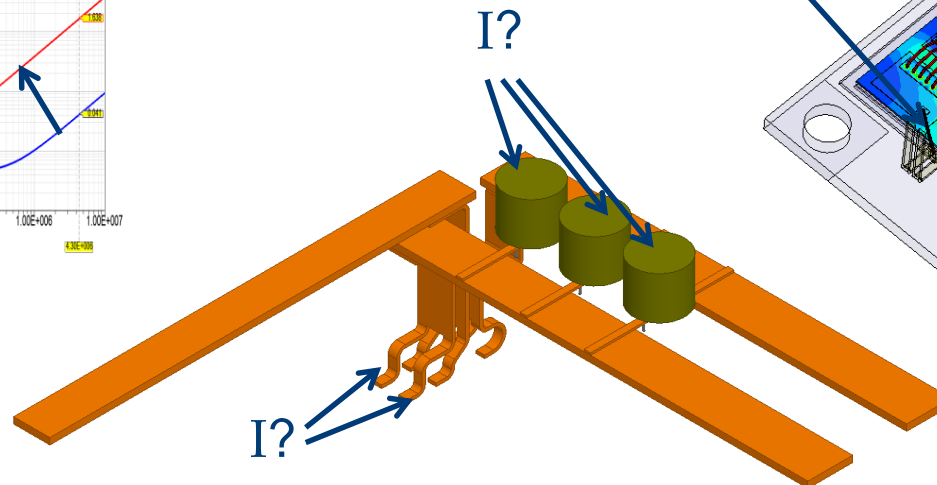


# Impact of Parasitic Inductances of the Layout

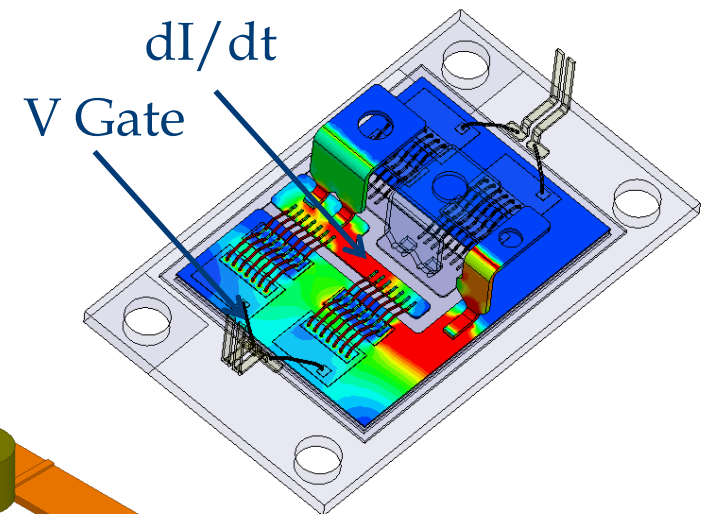
Parasitic inductances of connection to bus capacitors or parallel IGBTs move resonance to lower frequencies!



Uneven current distribution during switching in parallel circuits

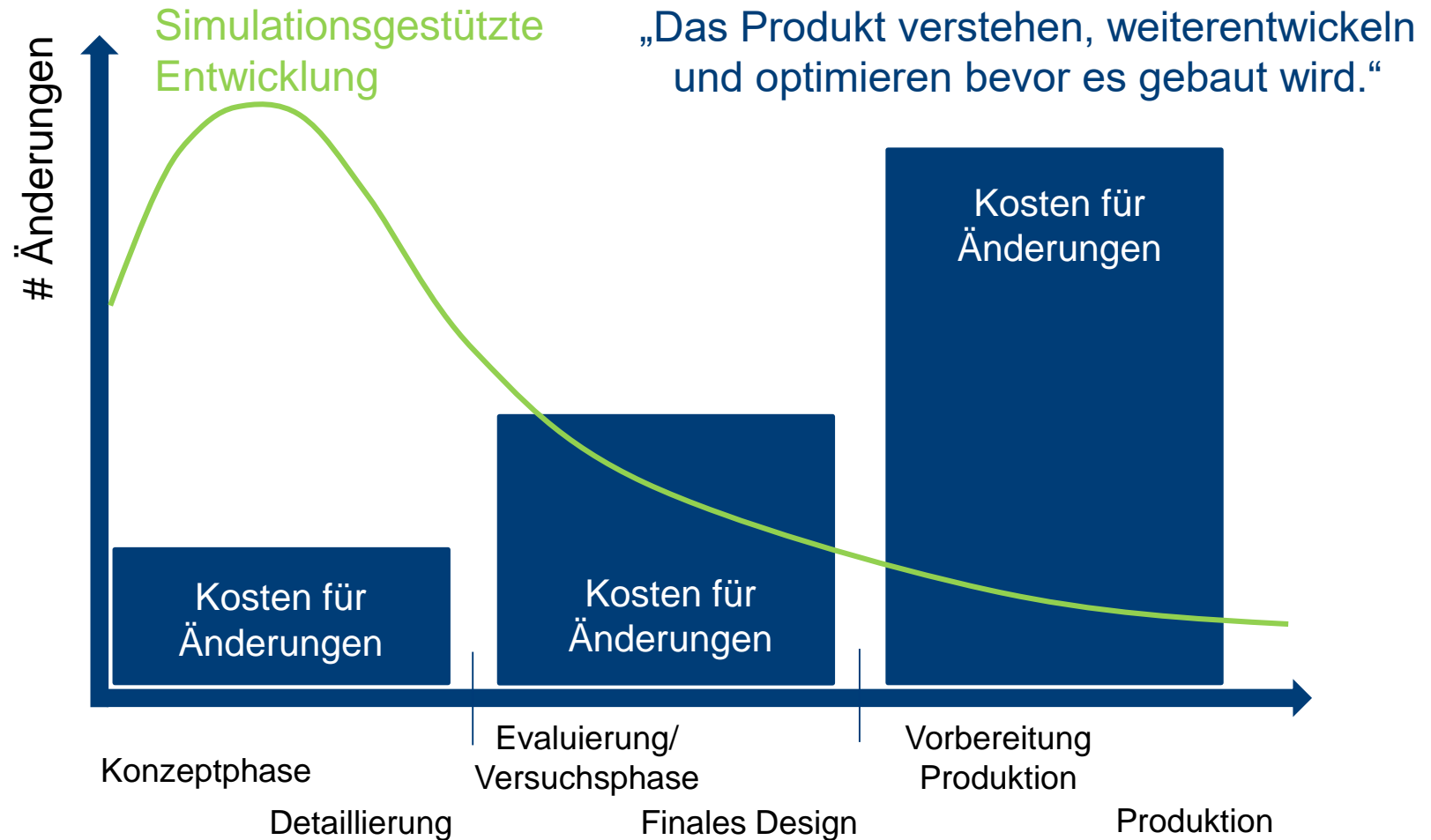


Inductive feedback of load currents to gate drive





# Simulationsgestützte Entwicklung



## Extraction of Parasitic RLC

- Fast and easy extraction for
  - Bus bars
  - Powermodules
  - Packages
  - PCBs
  - Cables
  - Connectors
- Different scales!

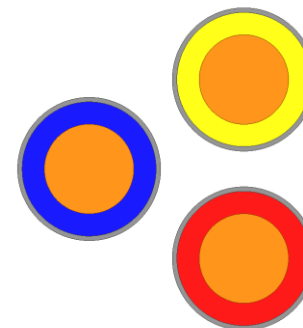
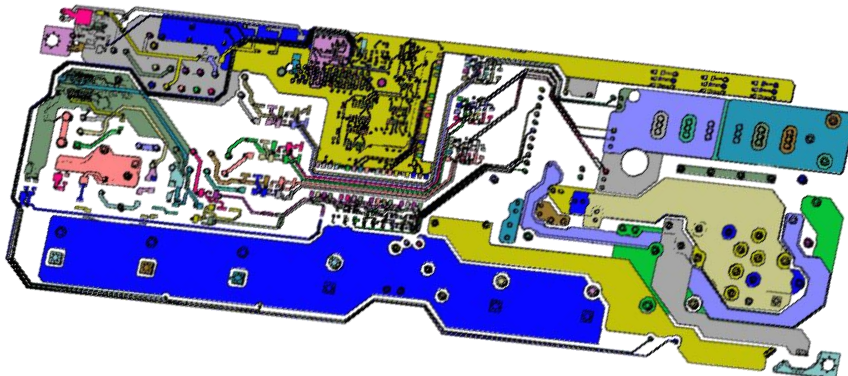
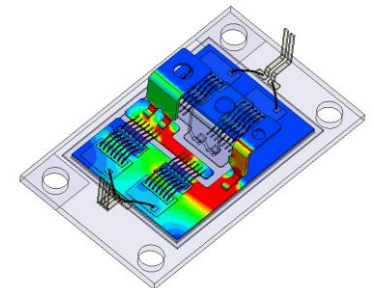
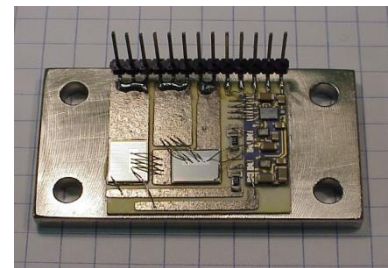
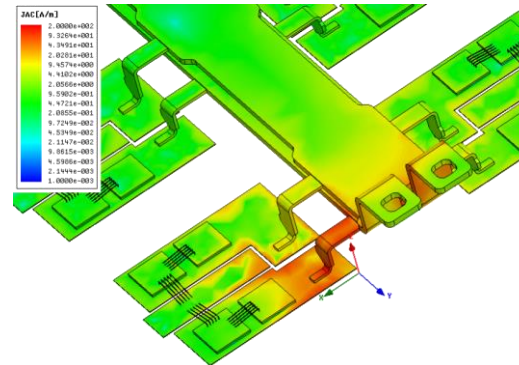


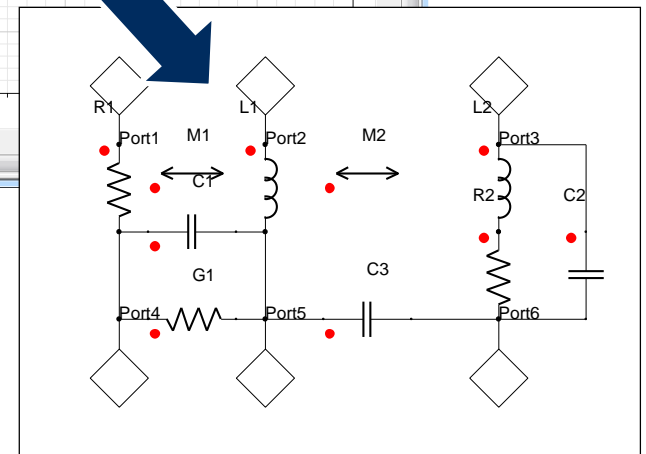
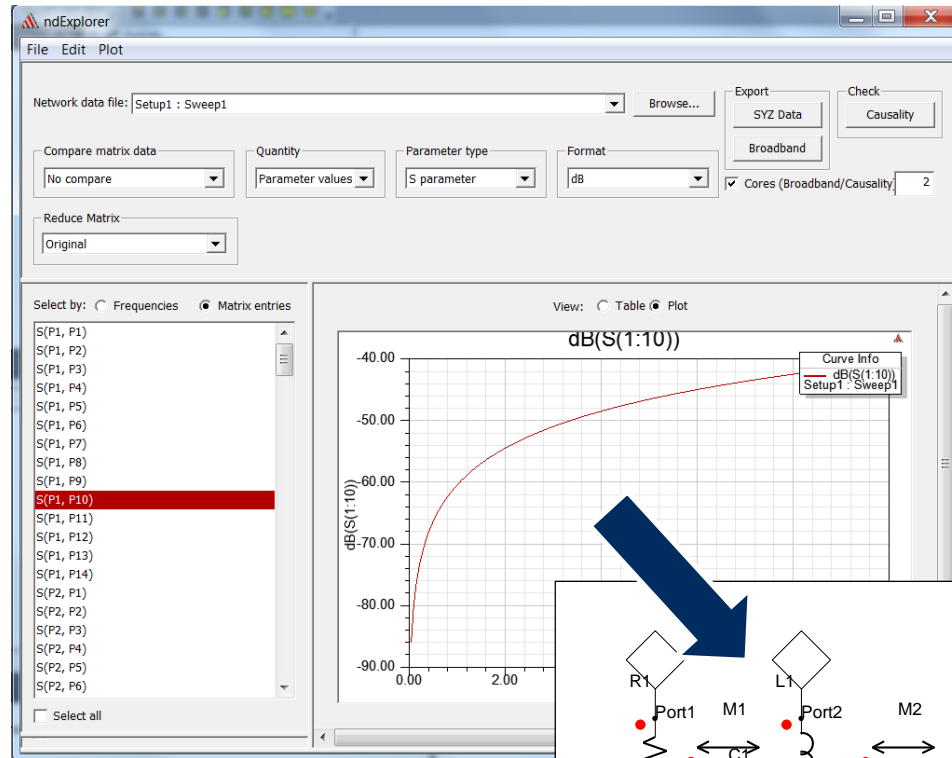
Image source: ANSYS, CADFEM

# Export of SPICE Models

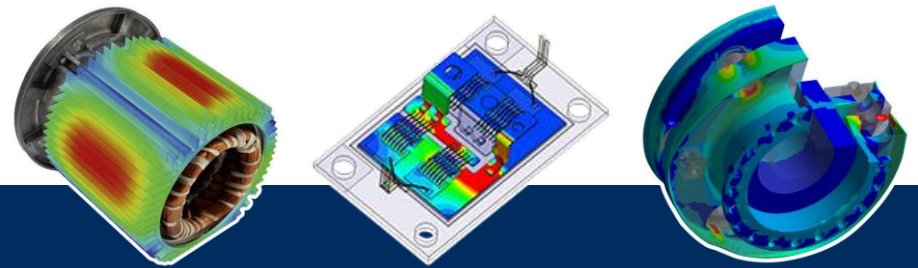
Formats:

PSPICE, HSPICE,  
Spectre, Nexxim,  
Simplorer, Touchstone

Fast insight into circuit  
design taking into  
account layout parasitics

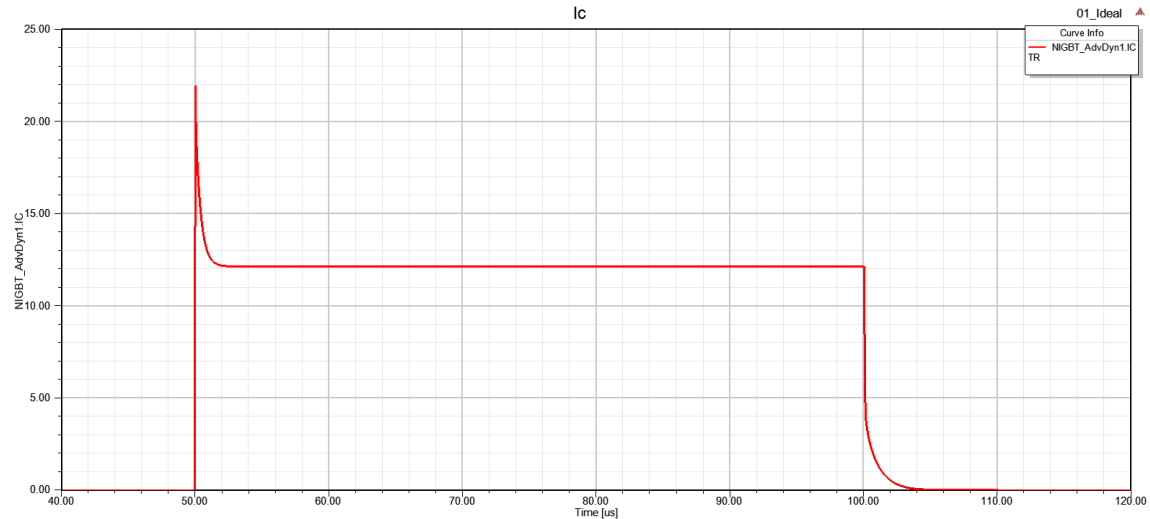
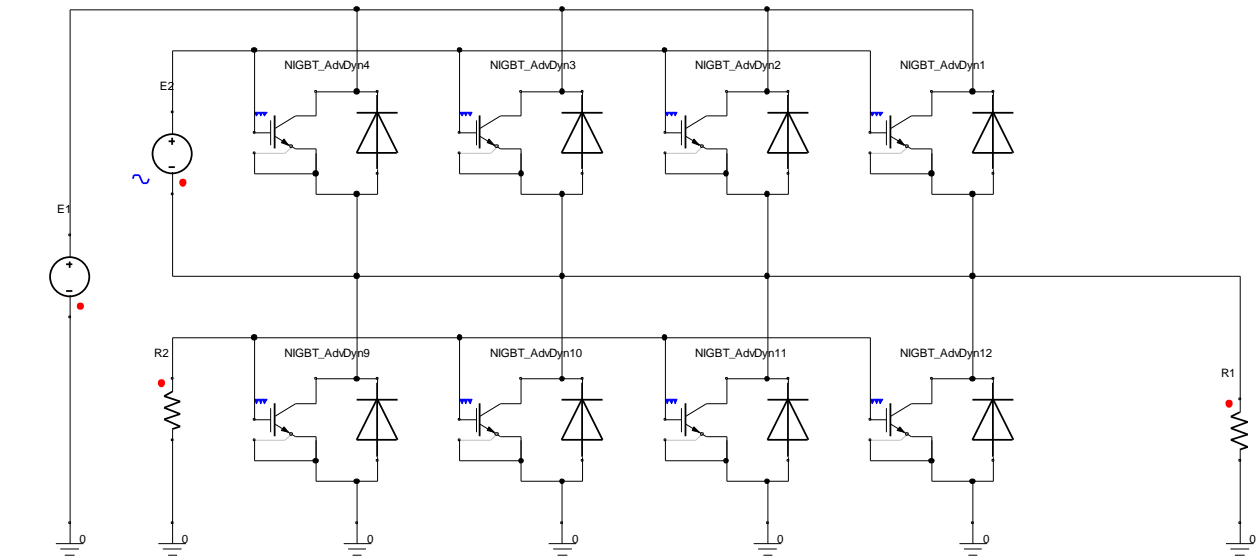


Simulation is more than Software<sup>®</sup>



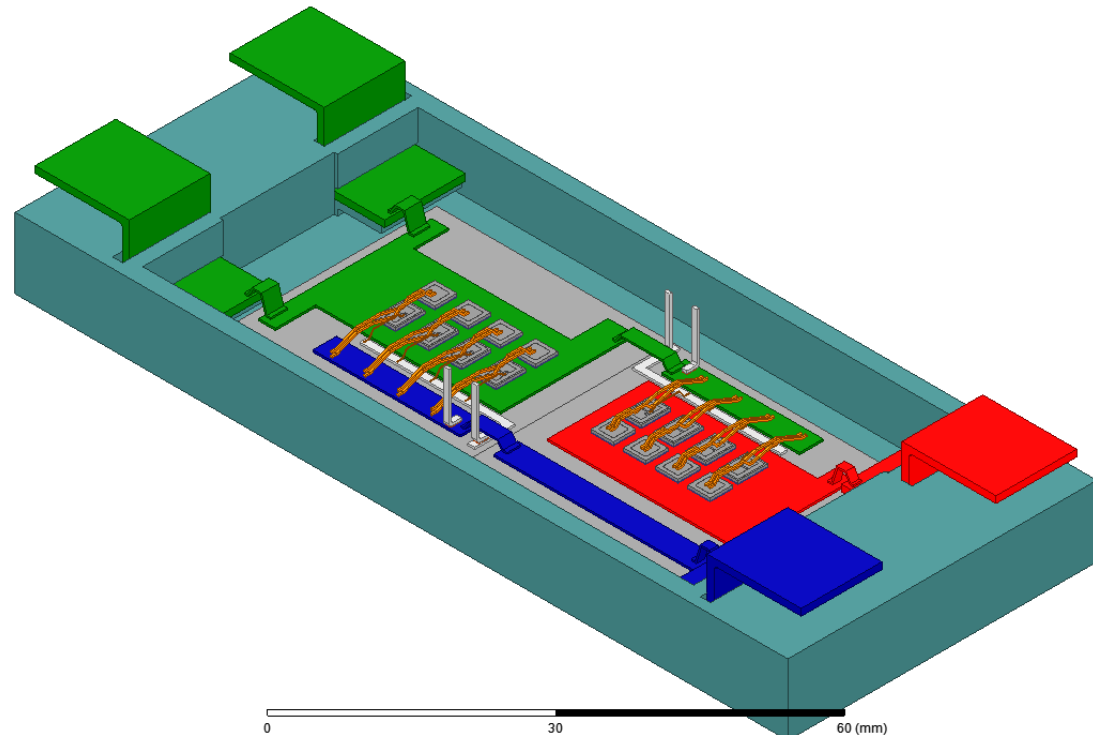
## Impact of Parasitics on the Performance of Inverters

# High Side Test



# Impact of Parasitics on the Performance of Inverters

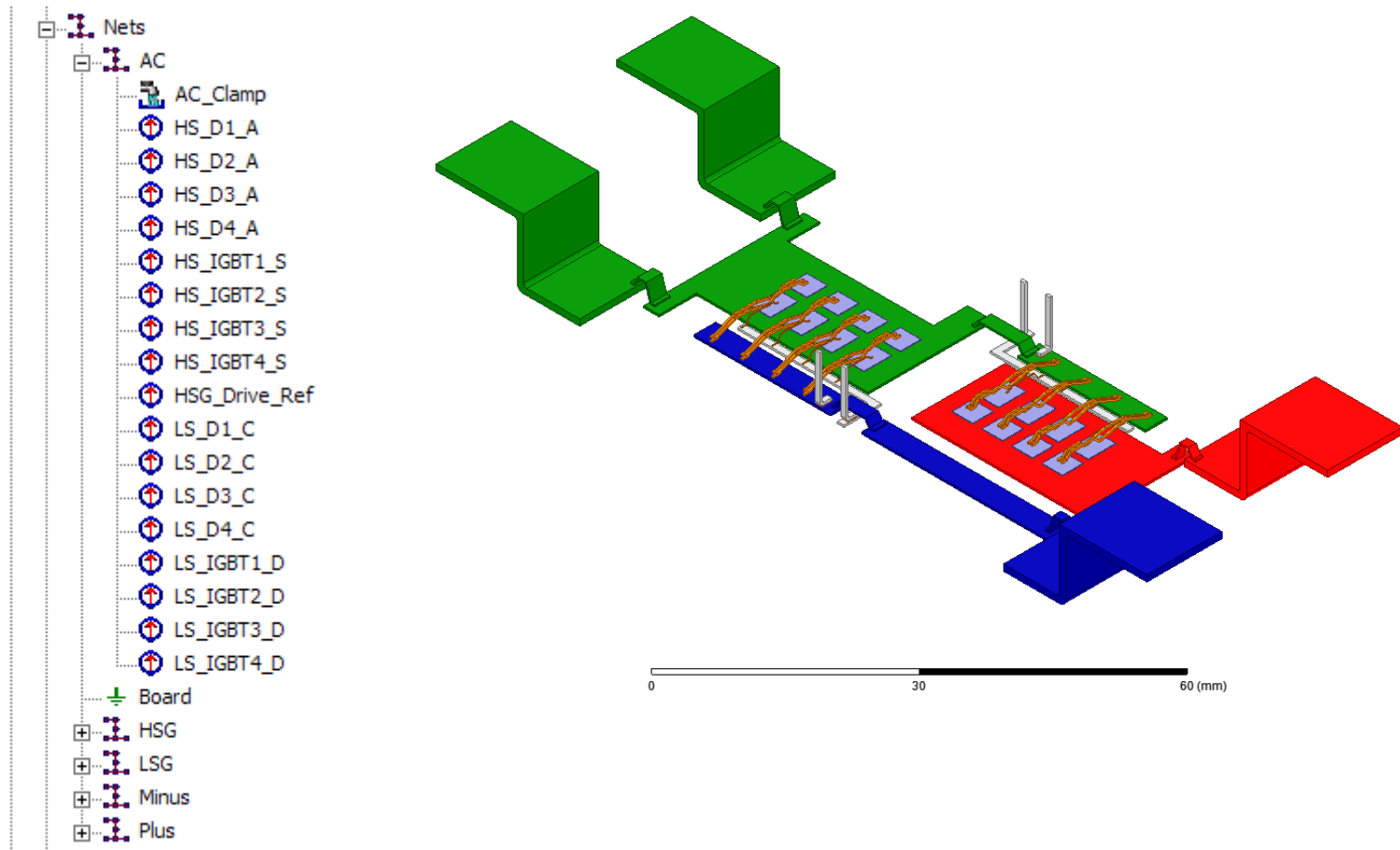
- Half-bridge module





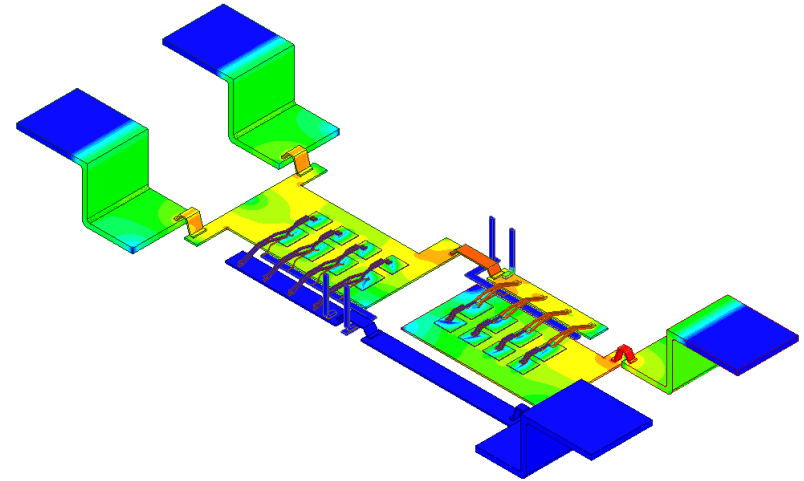
# Impact of Parasitics on the Performance of Inverters

- Half-bridge module: Electrical Nets and Terminals

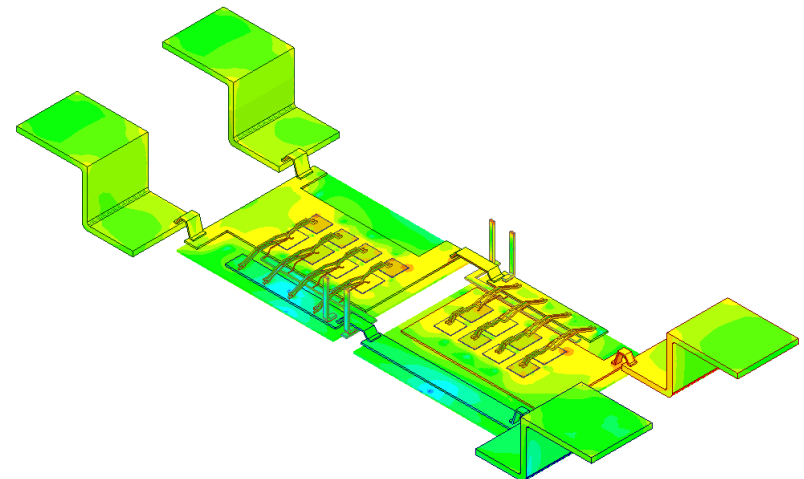


# Current Distributions

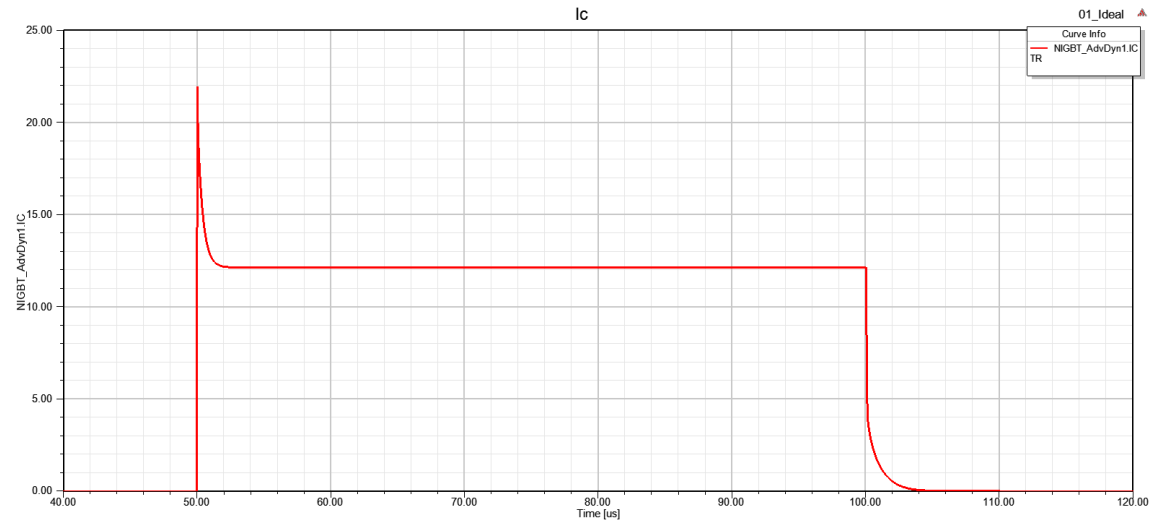
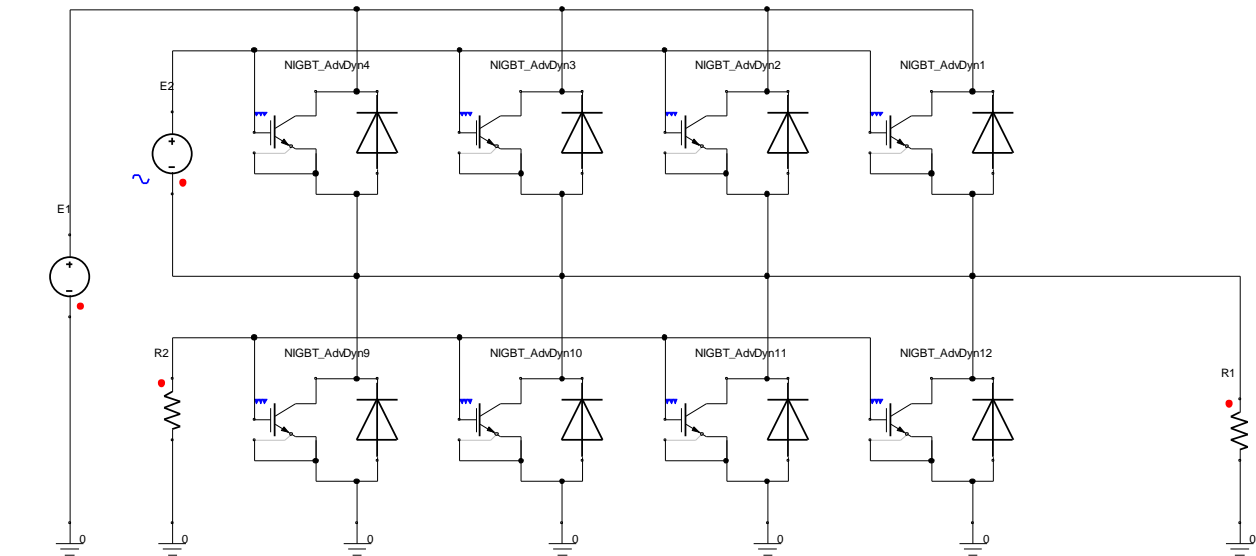
- DC currents



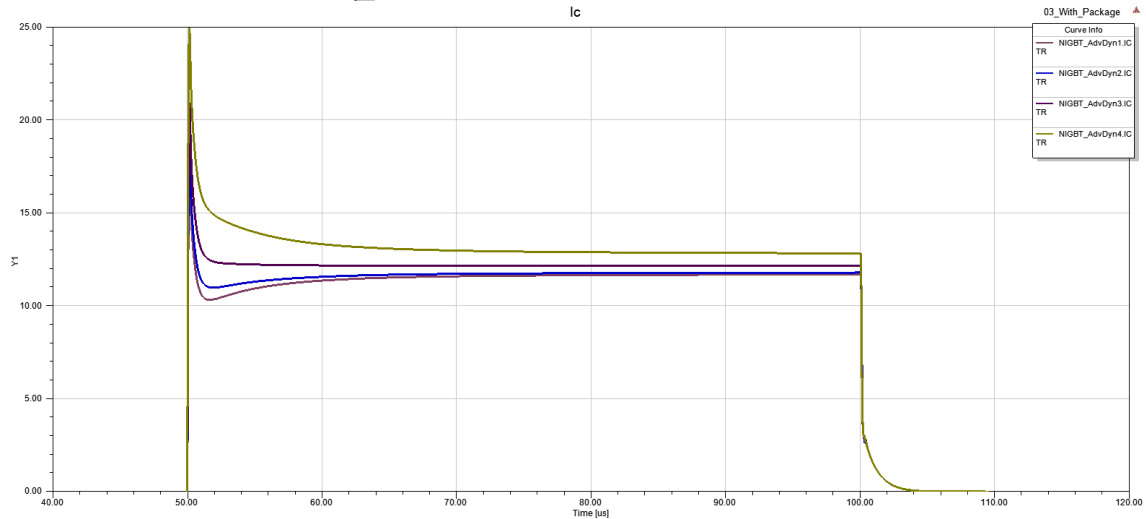
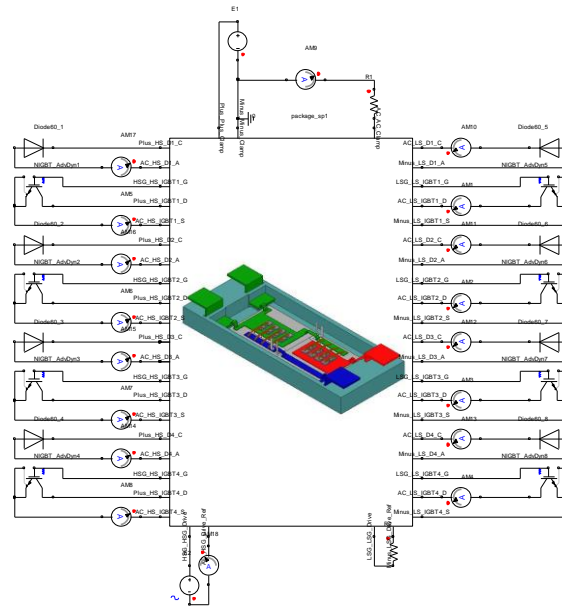
- AC currents – proximity effect!



# High Side Test

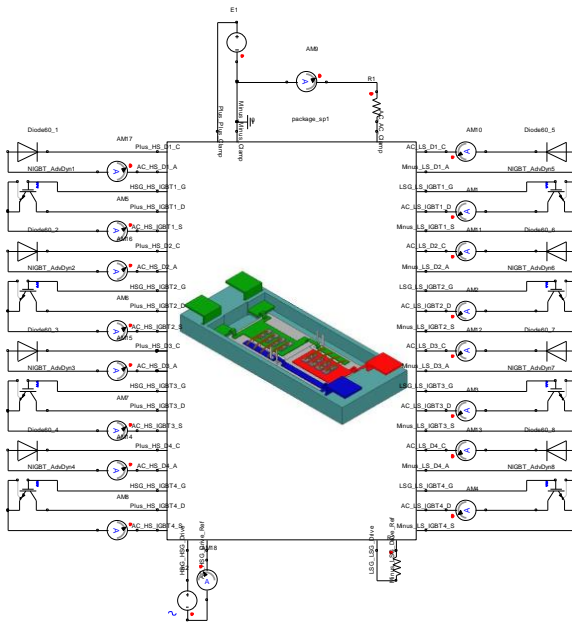


# High Side Test

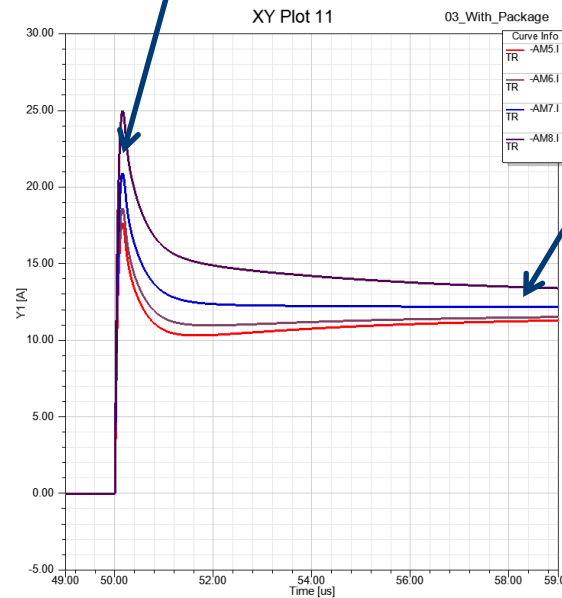


# Transient Simulation of Signales

- Switching edges
- Short circuit
- Conducted emissions

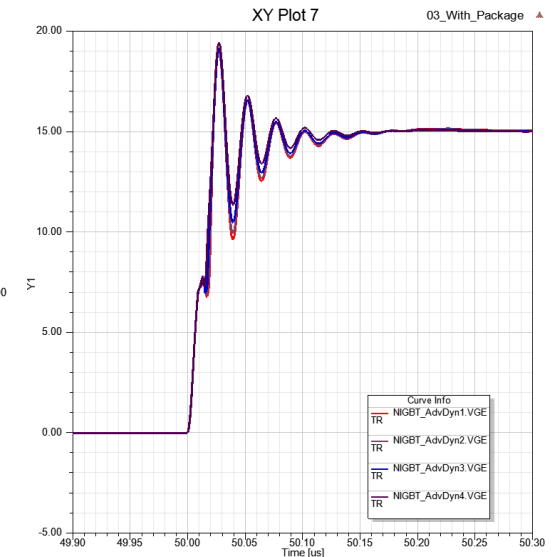


Dominated by  
AC inductance



Currents through HS IGBTs

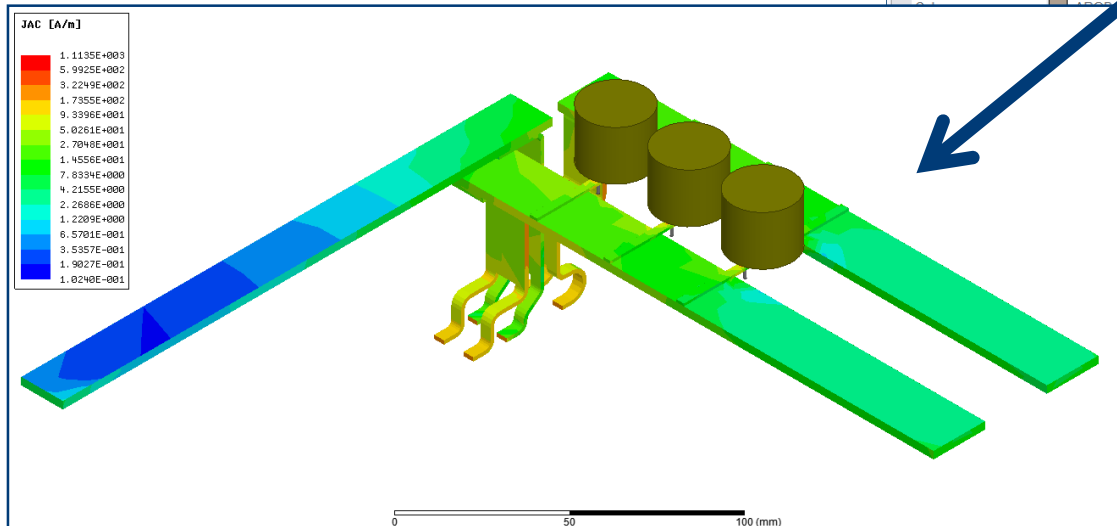
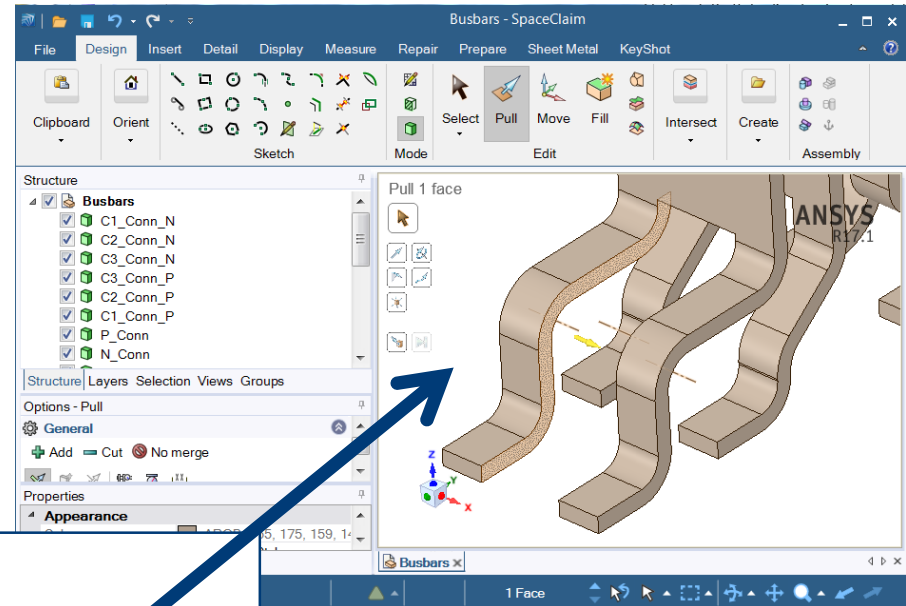
Dominated by  
DC resistance



Gate voltages at HS IGBTs

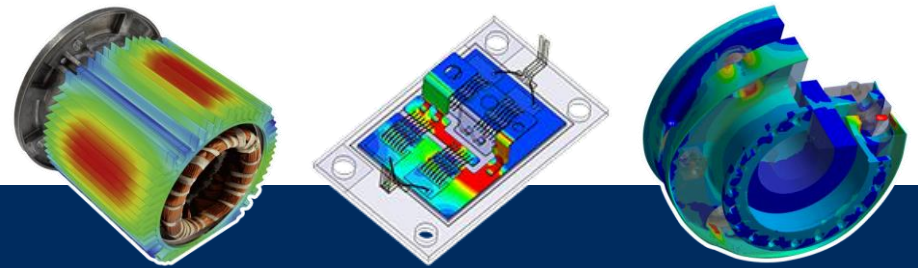
## Fast Variation for 'Proof of Concept'

- Quickly find and optimize design
  - Connection to parametric geometries
  - Easy modification of geometries using ANSYS SpaceClaim direct modeler





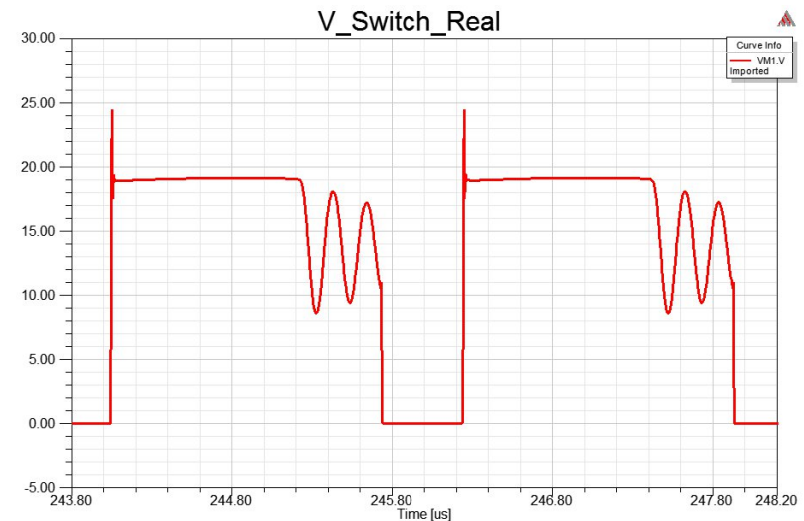
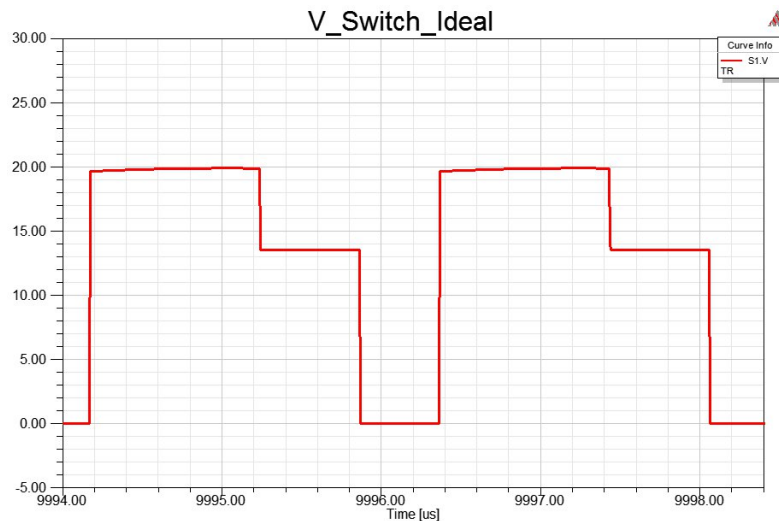
Simulation is more than Software<sup>®</sup>



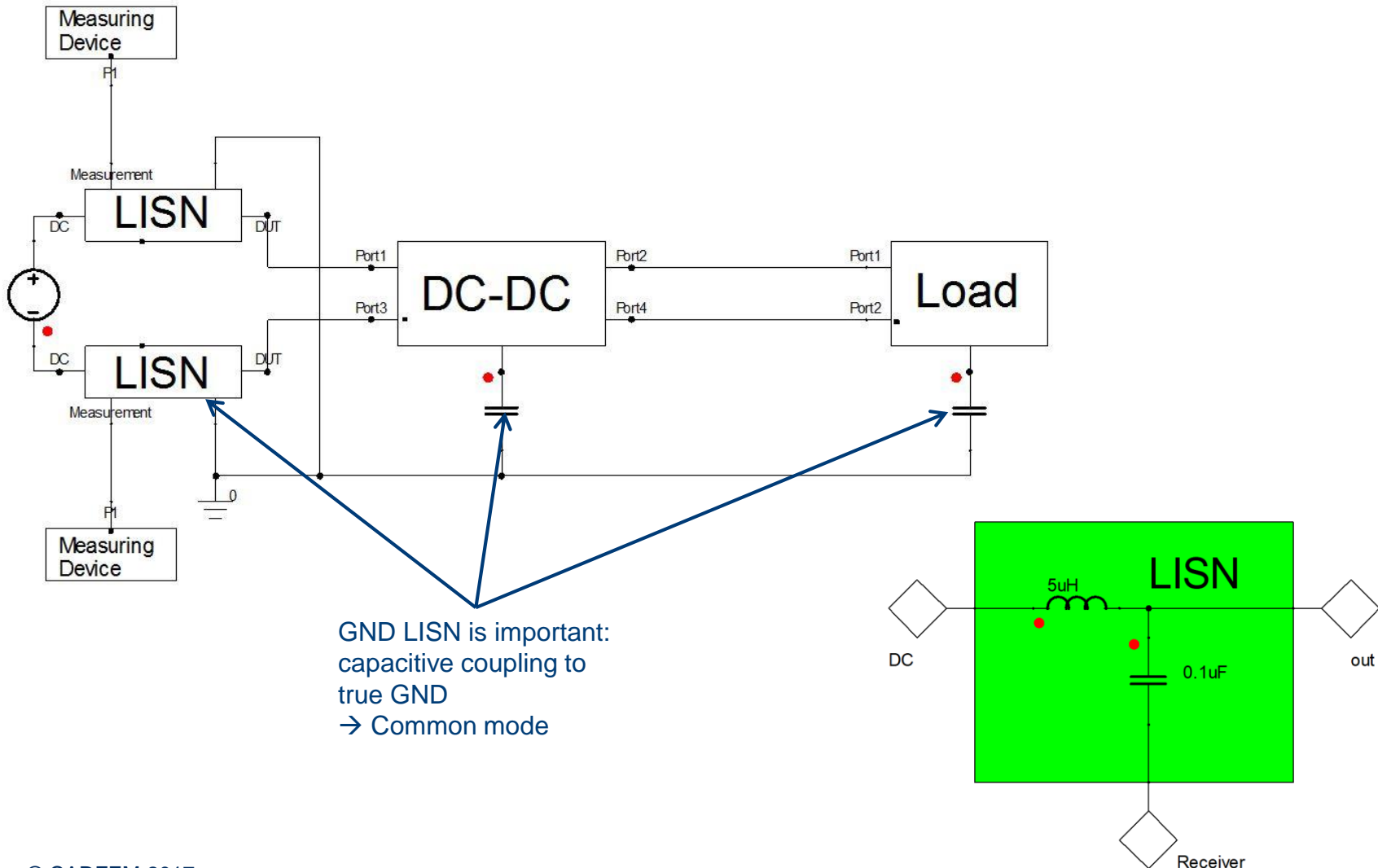
## Conducted Emissions of a DC-DC Converter

# Modeling for EMI Simulation

- Lower part of emissions spectrum well described by ideal circuit
- Need to take parasitics into account in order to describe the higher harmonics!
  - Spikes, overshooting
  - Parasitic oscillations

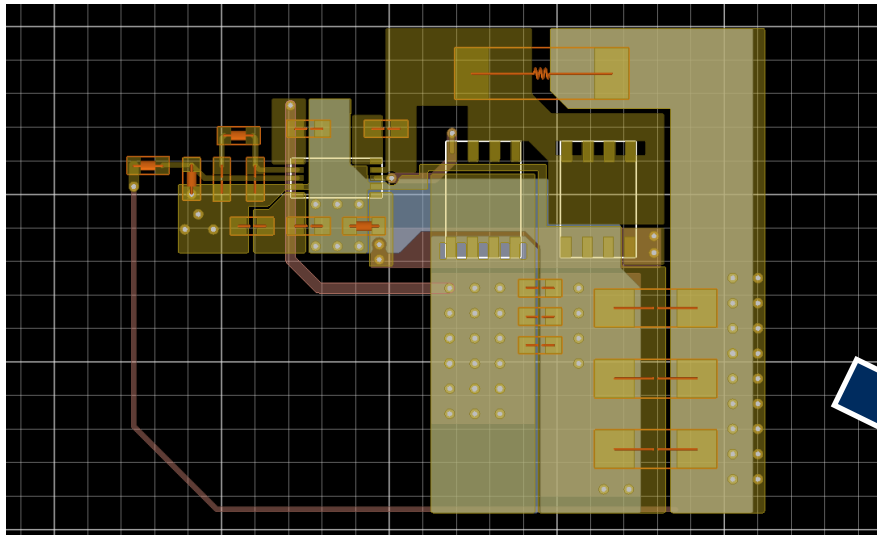


# Quantifying Emissions according to CISPR 25 Standard

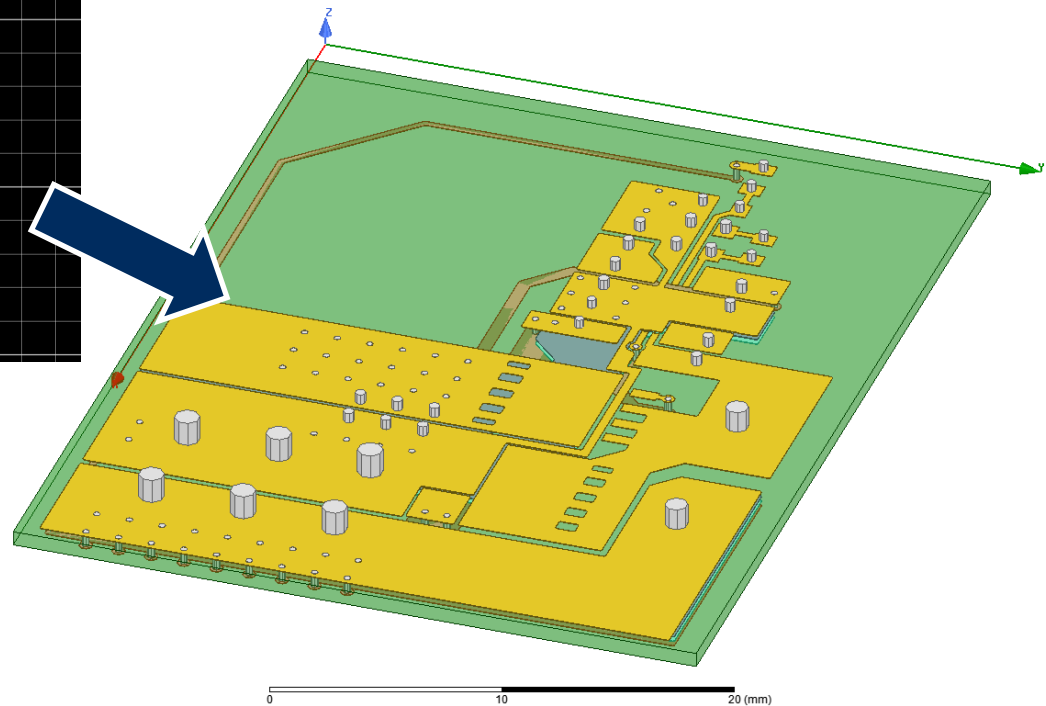


## Tools and Workflows – ECAD/Layout

- Layout Import and Setup of Terminals in Slwave

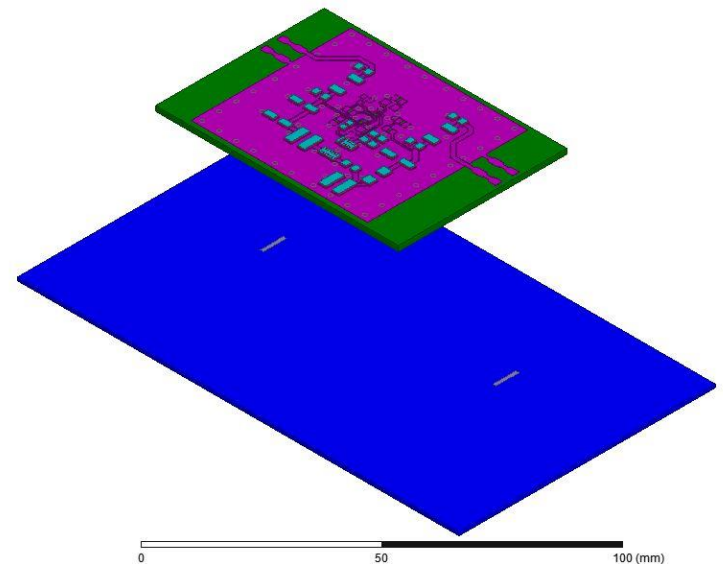
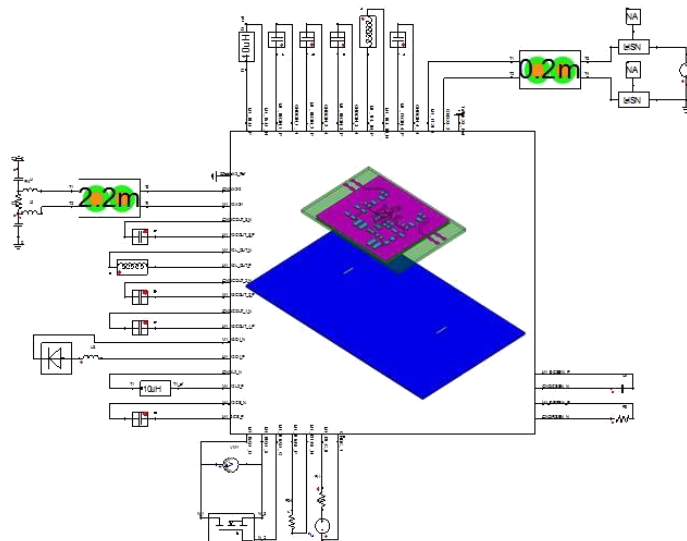
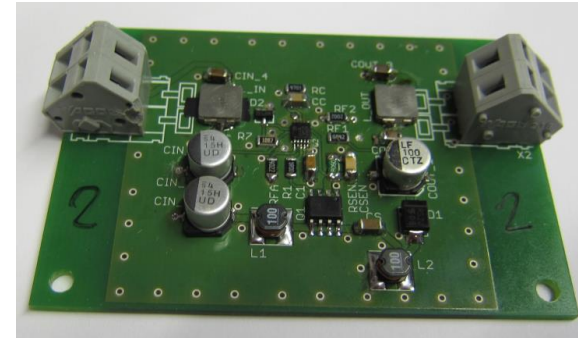


- RLCG Extraction in Q3D



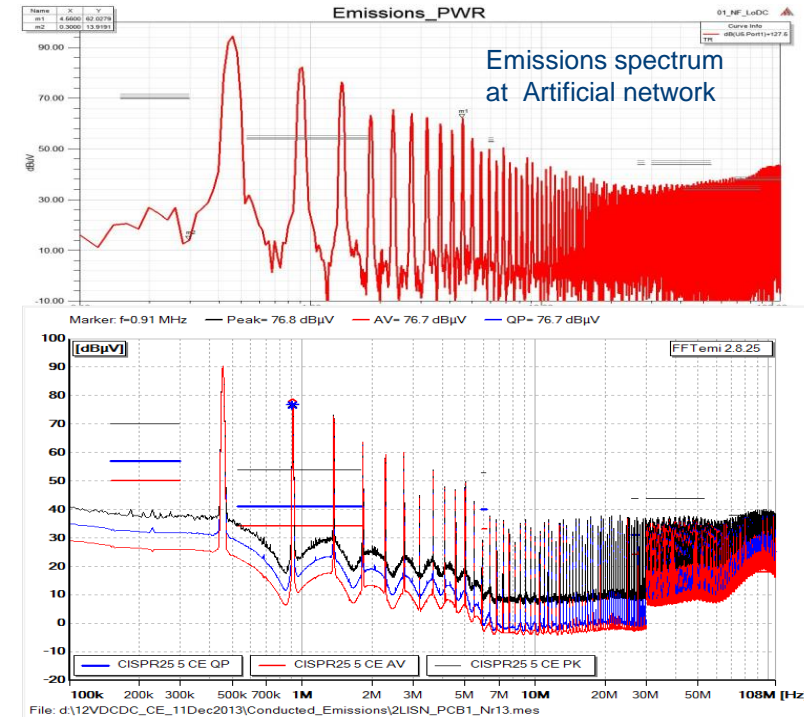
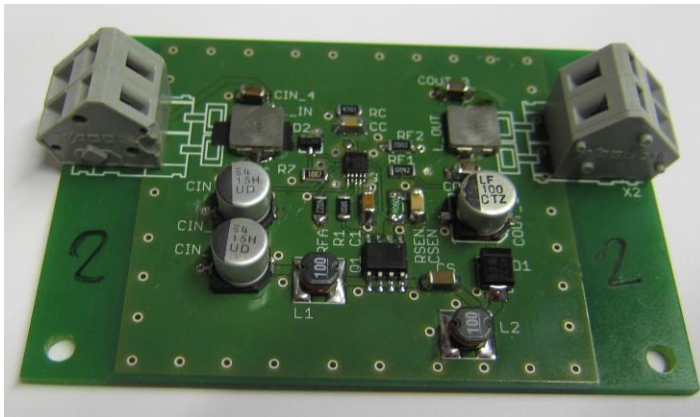
# Modeling for EMI Simulation

- Parasitic RLC of PCB and harness from field simulation
- Parasitics of passive components from measurement
- Dynamic behavioral models of active components



## Simulation of Conducted Emissions of a DC-DC Converter

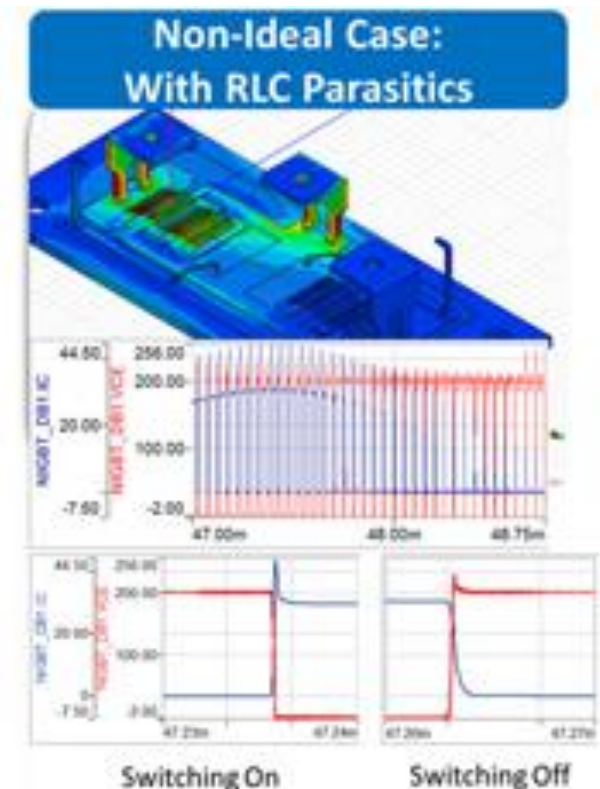
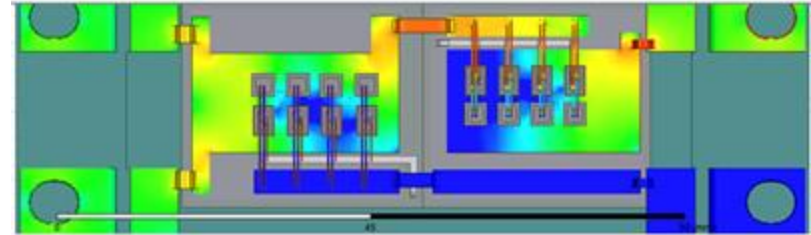
- Goal:
  - Understand coupling mechanisms of interferences
  - Find efficient countermeasures
  - Evaluate different countermeasures
- Good agreement with measurement





## Key Technology – ANSYS Q3D Extractor

- Fast, accurate 3-D parasitic extraction
  - Capacitance, conductance
  - DC RL
  - AC RL
- Results include proximity and skin effect, dielectric and Ohmic loss, and frequency dependencies
- Automatic adaptive meshing
- Equivalent circuit model creation
  - Simplorer State space model
  - PSpice, HSPICE, Spectre, IBIS ICM/PKG



## CADFEM – Simulation is more than Software

### PRODUCTS

Software und IT Solutions

### SERVICES

Advice, Support, Engineering

### KNOW-HOW

Transfer of knowledge

### CADFEM in D, A, CH

- 1985 founded
- 2,300 customers
- 11 locations
- 220 employees (worldwide > 350)
- ANSYS Elite Channel Partner

